

ESD Protection Diodes Silicon Epitaxial Planar

# DF2B29FU

## 1. Applications

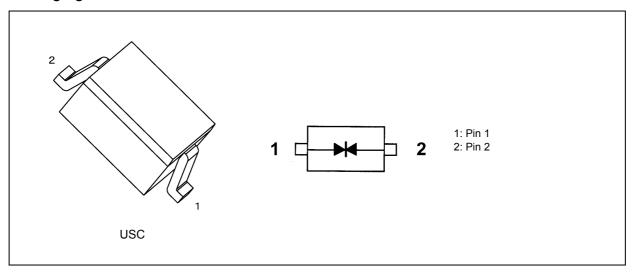
· ESD Protection

Note: This product is designed for protection against electrostatic discharge (ESD) and is not intended for any other purpose, including, but not limited to, voltage regulation.

#### 2. Features

(1) AEC-Q101 qualified (Please see the orderable part number list)

## 3. Packaging and Internal Circuit



#### 4. Orderable part number

Orderable part number	AEC-Q101		Note		
DF2B29FU,H3F	_		General Use		
DF2B29FU,H3XGF	YES	(Note 1)	Unintended Use	(Note 1)	
DF2B29FU,H3XHF	YES		Automotive Use		

Note 1: For more information, please contact our sales or use the inquiry form on our website.

Start of commercial production



#### 5. Absolute Maximum Ratings (Note) (Unless otherwise specified, T<sub>a</sub> = 25°C)

Characteristics	Symbol	Note	Rating	Unit
Electrostatic discharge voltage (IEC61000-4-2)(Contact)	V <sub>ESD</sub>	(Note 1)	±25	kV
Electrostatic discharge voltage(IEC61000-4-2)(Air)				
Electrostatic discharge voltage(ISO10605)(Contact)	V <sub>ESD</sub>	(Note 2)	±30	kV
Electrostatic discharge voltage(ISO10605)(Air)				
Peak pulse power	P <sub>PK</sub>		140	W
Peak pulse current	I <sub>PP</sub>	(Note 3)	3	Α
Junction temperature	Tj		150	°C
Storage temperature	T <sub>stg</sub>		-55 to 150	°C

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: According to IEC61000-4-2.

Note 2: According to ISO10605. (@ C = 330 pF, R =  $2 \text{ k}\Omega$ )

Note 3: According to IEC61000-4-5.



## 6. Electrical Characteristics (Unless otherwise specified, Ta = 25°C)

 $V_{\text{RWM}}$ : Working peak reverse voltage

V<sub>BR</sub>: Reverse breakdown voltage I<sub>BR</sub>: Reverse breakdown current

I<sub>R</sub>: Reverse current V<sub>C</sub>: Clamp voltage I<sub>PP</sub>: Peak pulse current R<sub>DYN</sub>: Dynamic resistance

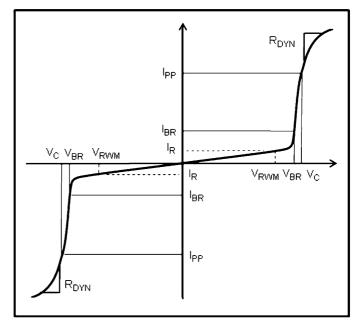


Fig. 6.1 Definitions of Electrical Characteristics

Characteristics	Symbol	Note	Test Condition	Min	Тур.	Max	Unit
Working peak reverse voltage	$V_{RWM}$		_	_	_	24	V
Reverse breakdown voltage	$V_{BR}$		I <sub>BR</sub> = 1 mA	26	_	32	٧
Reverse current	I <sub>R</sub>		V <sub>RWM</sub> = 24 V	_	_	0.1	μА
Clamp voltage	V <sub>C</sub>	(Note 1), (Note 3)	I <sub>PP</sub> = 1 A	_	30	_	٧
			I <sub>PP</sub> = 3 A	_	37	47	
Dynamic resistance	R <sub>DYN</sub>	(Note 2)	_	_	1.1	_	Ω
Total capacitance	Ct		V <sub>R</sub> = 0 V, f = 1 MHz	_	9	10	pF

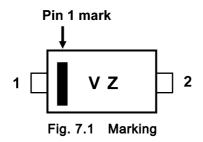
Note 1: Based on IEC61000-4-5 8/20 µs pulse.

Note 2: TLP parameter: Z0 = 50  $\Omega$ , tp = 100 ns, tr = 300 ps, averaging window: t1 = 30 ns to t2 = 60 ns, extraction of dynamic resistance using a least-squares fit of TLP characteristics at IPP between 8 A to 16 A.

Note 3: Guaranteed by design.



## 7. Marking



## 8. Land Pattern Dimensions (for reference only)

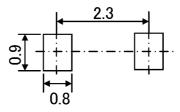


Fig. 8.1 Land Pattern Dimensions (Unit: mm)



## 9. Characteristics Curves (Note)

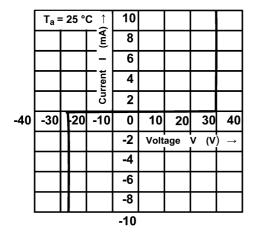
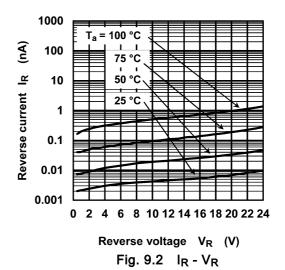
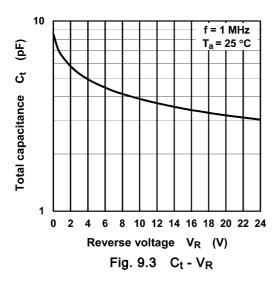


Fig. 9.1 I - V

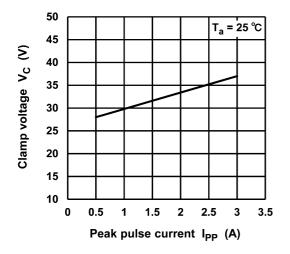




Note: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.



## 10. Clamp Voltage V<sub>C</sub> - Peak Pulse Current (I<sub>PP</sub>) (Note)



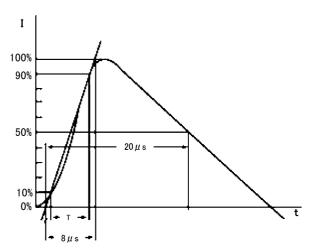


Fig. 10.1 V<sub>C</sub> - I<sub>PP</sub>

Fig. 10.2 Based on IEC61000-4-5 8/20  $\mu$ s pulse. (Ed.2)

Note: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.



## 11. ESD Clamp Waveform (Note)

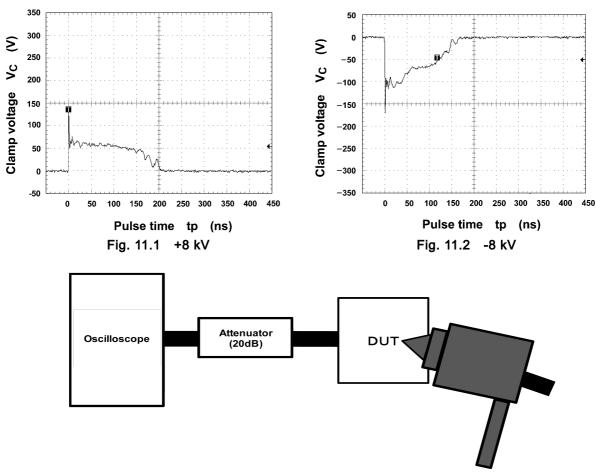


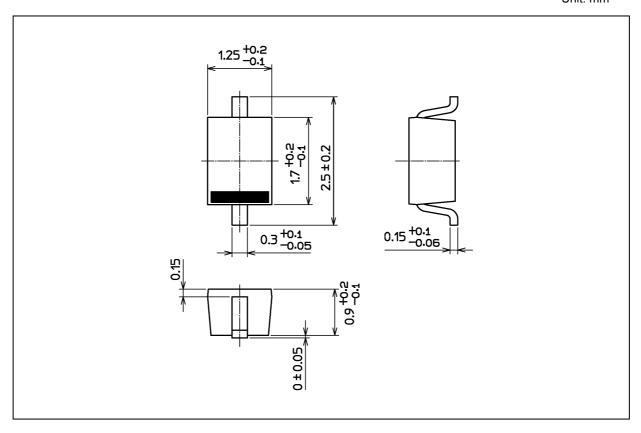
Fig. 11.3 IEC61000-4-2 (Contact)

Note: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.



## **Package Dimensions**

Unit: mm



Weight: 4.5 mg (typ.)

	Package Name(s)
Nickname: USC	

Rev.3.0



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